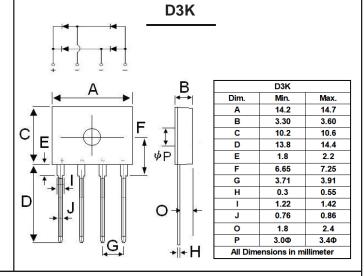


## **FEATURES**

- \* Ideal for printed circuit board
- \* Low forward voltage
- \* Low leakage current
- \* Polarity: marked on body
- \* Mounting position: Any

## VOLTAGE RANGE 600 to 1000 Volts CURRENT 3.0 Ampere



# MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwies specified. Single phase half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

	Symbols	D3UB60	D3UB80	D3UB100	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	600	800	1000	Volts
Maximum RMS Voltage	$V_{RMS}$	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	600	800	1000	Volts
Maximum Average Forward Rectified Current .375"(9.5mm) Lead Length at $T_A$ =50	I <sub>(AV)</sub>	3.0			Amp
Peak Forward Surge Current,					
8.3ms single half-sine-wave	I <sub>FSM</sub> 70			Amp	
superimposed on rated load (JEDEC method)					
Maximum Forward Voltage	$V_{\rm F}$	1.1			Volts
at 3.0A DC and 25	V F				
Maximum Reverse Current at T <sub>A</sub> =25	I <sub>R</sub>	10.0			uAmp
at Rated DC Blocking Voltage T <sub>A</sub> =100	1 <sub>R</sub>		500	500	
Typical Junction Capacitance (Note 1)	$C_{\mathrm{J}}$	25			pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	30			/W
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$	16			/W
Operating and Storage Temperature Range	T <sub>J</sub> , Tstg		-55 to +150		

#### NOTES:

- 1- Measured at 1 MH<sub>z</sub> and applied reverse voltage of 4.0 VDC.
- 2- Thermal Resistance Junction to Ambient and form junction to lead at 0.375"(9.5mm) lead length P.C.B. Mounted.

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### RATING AND CHARACTERISTIC CURVES (D3UB60 THRU D3UB100)

